



ON Semiconductor®

SENT "New sensor interface"

Allows data-transmission at low cost

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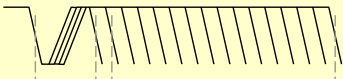
What is SENT?

-Sensor-interface:

- Digital data-transmission at 30 kbits/s
- Low-cost: No receiver, Integrated transmitter
- Uni-directional: only from sensor to ECU
- Point-to-point: no bus
- 3 wires: 5V, GND, SENT
- J2716 SAE-standard

-SENT: Single Edge Nibble Transmission for Automotive applications

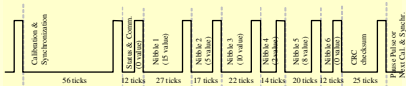
- Data transmitted as nibbles (4 bits). Maximum of 6 nibbles per message.



Clock Ticks: 0 [12] 13 14 ... [27]
Nibble Value (4-bit): 0 [1] 2 ... [15]

- Time measured between falling edges (single edges)

- Frame-format:



- Calibration or synchronization pulse: Fixed length for synchronization of receiver (56 clock-ticks).

- Status & Communication Nibble defines message format:

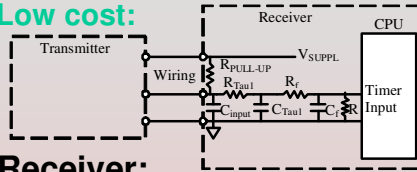
- No Serial Protocol
- Short Serial Protocol
- Enhanced Serial Protocol
- Checksum-Nibble: 4 bit CRC
- Pause-Pulse: to fill-up message to a fixed length (less than 1ms).

Goal of SENT?

- Low cost
- Digital precision: advantage over analog or semi-analog PWM int.
- Higher baudrate than LIN.

Challenges: !!!

-Low cost:



-Receiver:

- Only passive components at receiver-side
- Digital input at CPU

-Timing requirements:

- Clock-drift* error < 0,05us
- * Clock-drift = variation of nibble length over a message-period at a 3 μs clock tick.

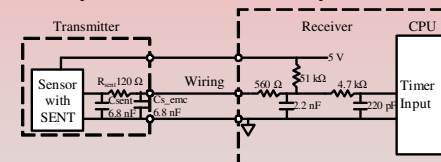
-Automotive requirements:

- Wiring problems:
 - Wiring short to supply (→ reverse battery)
 - Wiring short to ground (→ output-prot.)
- Automotive transients:
 - For supply-line and signal-line.
- ESD-immunity:
 - System ESD (8kV contact, 15kV air: C = 330pF, R = 2kΩ)
- EMC-requirements:
 - Susceptibility: conducted and radiated class A under 200mA BCI; 4W PDI to supply or SENT wire; 200V/m TEM cell
 - Emission: conducted and radiated

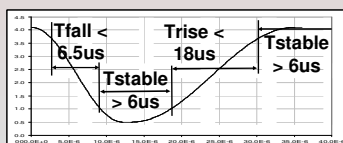
Contribution of ON Semiconductor:

-Participation to SAE- SENT task-force led by GM:

- Transmitter-def.: push-pull driver.
- Proposal for external components:



- Check feasibility of emission requirements at maximum baudrate:



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SENT IP:

-Meeting all automotive requirements.

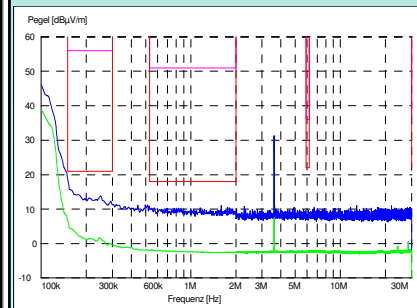
- In production as part of sensor-ASIC.

Emission requirement:

- Signal freq. content:
 - Min. pulse-width: 36us – 20% = 29us
 - Corresponding freq. ~ 35 kHz
 - Falling edge: from 3.8V to 1.1V <6.5us
 - Corresponding freq. ~ 66 kHz
- Absorber-lined chamber limits: CISPR 25 <21dBμV 150kHz .. 300kHz

Implementation:

- Signal shaping to suppress higher harmonics without impacting:
 - Pulse-shape
 - Timing requirements
 - Signal amplitude
- Measurement results:
 - Radiated Emission, Absorber-lined Chamber



blue: peak detector
green: average detector

References:

-SAE J2716 – Information Report FEB2008

Acknowledgements:

- Petr Kamenicky + Brno design team for development of SENT-IP and integration in Sensor-ASIC.
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